The SN54LS07 and SN74LS17 are obsolete and are no longer supplied.

SN54LS07, SN74LS07, SN74LS17 HEX BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

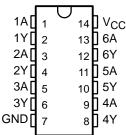
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- Convert TTL Voltage Levels to MOS Levels
- High Sink-Current Capability
- Input Clamping Diodes Simplify System Design
- Open-Collector Driver for Indicator Lamps and Relays

description

These hex buffers/drivers feature high-voltage open-collector outputs to interface with high-level circuits or for driving high-current loads. They are also characterized for use as buffers for driving TTL inputs. The 'LS07 devices have a rated output voltage of 30 V, and the SN74LS17 has a rated output voltage of 15 V. The maximum sink current is 30 mA for the SN54LS07 and 40 mA for the SN74LS07 and SN74LS17.

SN54LS07 . . . J PACKAGE SN74LS07, SN74LS17 . . . D, DB, N, OR NS PACKAGE (TOP VIEW)



These circuits are compatible with most TTL families. Inputs are diode-clamped to minimize transmission-line effects, which simplifies design. Typical power dissipation is 140 mW and average propagation delay time is 12 ns.

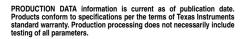
ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
0°C to 70°C	SOIC - D	Tube	SN74LS07D	LS07	
	30IC - D	Tape and reel	SN74LS07DR	L307	
	SOIC - DB	Tape and reel	SN74LS07DBR	LS07	
	SOP - NS	Tape and reel	SN74LS07NSR	74LS07	
	PDIP – N Tube		SN74LS07N	SN74LS07N	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

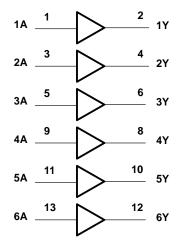


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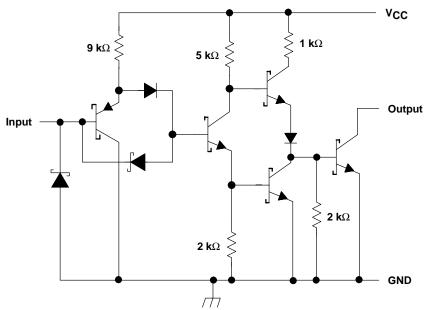




logic diagram (positive logic)



schematic (each gate)



Resistor values shown are nominal.

SN54LS07, SN74LS07, SN74LS17 HEX BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
	5.5 V
Output voltage, VO (see Notes 1 and 2): SN54LS07	, SN74LS07 30 V
SN74LS17	
Package thermal impedance, θ_{JA} (see Note 3): D package	ckage 86°C/W
	ackage 96°C/W
N pad	ckage 80°C/W
NS p	ackage 76°C/W
Storage temperature range Teta	-65°C to 150°C

NOTES: 1. All voltage values are with respect to GND.

- 2. This is the maximum voltage that should be applied to any output when it is in the off state.
- 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

			SN54LS07		SN74LS07 SN74LS17			UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage		4.5	5	5.5	4.75	5	5.25	V	
VIH	H High-level input voltage		2			2			V
V _{IL}	Low-level input voltage				0.8			0.8	V
VOH High-level output voltage	High lovel output veltage	'LS07			30			30	V
	High-level output voltage	SN74LS17						15]
loL	IOL Low-level output current				30			40	mA
TA	Q Operating free-air temperature		-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CO	TEST CONDITIONS‡		SN54LS07		SN74LS07 SN74LS17	
						MIN	MAX	
VIK	$V_{CC} = MIN,$	$I_{I} = -12 \text{ mA}$			-1.5		-1.5	٧
lavi	V _{CC} = MIN,	V _{IH} = 2 V	'LS07, V _{OH} = 30 V		0.25		0.25	mA
ЮН			SN74LS17, V _{OH} = 15 V				0.25	
, , , , , , , , , , , , , , , , , , ,	V _{CC} = MIN,	V _{IL} = 0.8 V	I _{OL} = 16 mA		0.4		0.4	V
VOL			I _{OL} = MAX§		0.7		0.7	
lį	$V_{CC} = MAX$,	V _I = 7 V			1		1	mA
lіН	$V_{CC} = MAX$,	V _I = 2.4 V			20		20	μΑ
Ι _{ΙL}	$V_{CC} = MAX$,	V _I = 0.4 V			-0.2		-0.2	mA
ICCH	$V_{CC} = MAX$				14		14	mA
ICCL	$V_{CC} = MAX$				45		45	mA

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

 $[\]S$ I_{OL} = 30 mA for SN54 series parts and 40 mA for SN74 series parts.

SN54LS07, SN74LS07, SN74LS17 HEX BUFFERS/DRIVERS WITH OPEN-COLLECTOR HIGH-VOLTAGE OUTPUTS SDLS021B - MAY 1990 - REVISED JANUARY 2002

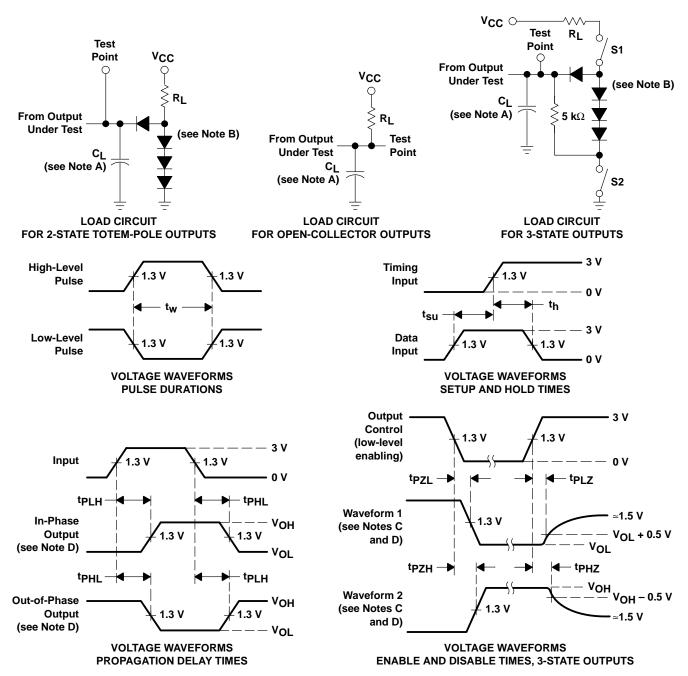
The SN54LS07 and SN74LS17 are obsolete and are no longer supplied.

switching characteristics, V_{CC} = 5 V, T_A = 25°C (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t _{PLH}	А	Y	$R_L = 110 \Omega$, $C_L = 15 pF$	C: = 15 pE		6	10	ne
t _{PHL}				OL = 15 pr		19	30	ns

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PARAMETER MEASUREMENT INFORMATION



- NOTES: A. C_L includes probe and jig capacitance.
 - B. All diodes are 1N3064 or equivalent.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
 - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
 - F. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_{O} \approx 50 \Omega$, $t_{f} \leq$ 1.5 ns, $t_{f} \leq$ 2.6 ns.
 - G. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265